

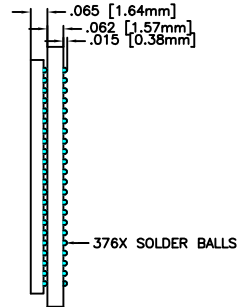
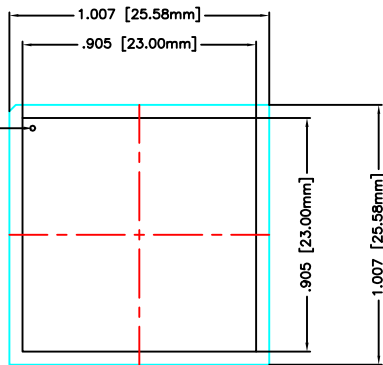
PIN SPECIFICATIONS:
 MATERIAL: BRASS ALLOY 360 1/2 HARD PER QQ-B-628
 FINISH: 10u GOLD OVER 100u NICKEL MIL-B-45204
 ELECTRICAL PERFORMANCE TESTS IAW MIL-STD-202 OR 1344 METHODS:
 MAX VOLTAGE: 50 VAC/60 VDC
 MAX CURRENT: 1 AMP
 CONTACT RES: 010 MAX .01 AMPS/5VDC
 INSULATION RESISTANCE: @500 VDC: 5000 MEGOHMS MIN.
 CAPACITANCE: 1pf MAX
 SELF INDUCTANCE: 2nH MAX.

MATERIAL SPECIFICATIONS:
 STANDARD MATERIAL:
 GLASS EPOXY FR-4, IPC-4101/24,
 MIL-S-13949/04-07/090UL
 94V-0, CONTINUOUS USE TEMP 150C,
 HEAT DEFLECTION TEMP(@264 PSI)175C
 SOLDER BALL: 0206 Eutectic 63/37
 15 ps-95. MELTING TEMPERATURE
 183C

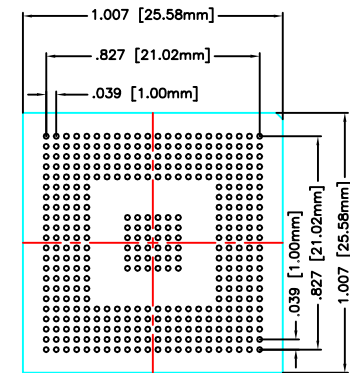
REVISIONS				
ZONE	REV	DESCRIPTION	DATE	APPROVED
---	A	NEW RELEASE	10/22/06	

TOP VIEW

ALIGN COMPONENT PIN A1
 WITH CHAMFER ON PCB.



BOTTOM VIEW



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ADAPTERS-PLUS
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CUSTOM BGA INTERPOSER
 CONVERTS 484 BGA TO 376 BGA FOR IDT.

DRAWN BY:
 ANDREW MONTOYA

CHECKED:
 MIKE OIDEM

SIZE	FSCM NO.	DWG NO.	REV
SCALE 2:1	DATE : 10/22/06	CA484BG-376BG-IDT	A
SHEET			